

APPROVAL SHEET

RFDIP Series - 2012(0805) - RoHS Compliance

MULTILAYER CERAMIC DIPLEXER

Halogens Free Product

2400 ~ 2500 / 5150 ~ 7500 MHz Working Frequency

P/N: RFDIP2010L38A7B1U

*Contents in this sheet are subject to change without prior notice.



FEATURES

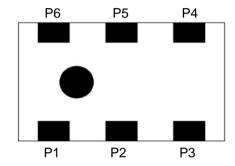
- 1. Miniature footprint: 2.0 X 1.25 X 1.0 mm³.
- 2. Low Insertion Loss
- 3. High Rejection Rate
- 4. LTCC Process

APPLICATIONS

1. 2400 ~ 2500 MHz / 5150 ~ 7500 MHz working frequency

CONSTRUCTION

Top view



PIN	Connection		
P1	GND		
P2	Common Port		
P3	GND		
P4	Lower Freq. Port		
P5	GND		
P6	Higher Freq. Port		

DIMENSIONS

Figure	Symbol	Dimension (mm)
L T	L	2.00 ± 0.15
Top view W	W	1.25 ± 0.15
Side view	Т	1.00 max.
Side view	А	0.20 ± 0.20
	В	0.30 ± 0.20
Bottom view	С	0.35 ± 0.20
†	D	0.65 ± 0.20
	E	0.20 ± 0.20



ELECTRICAL CHARACTERISTICS

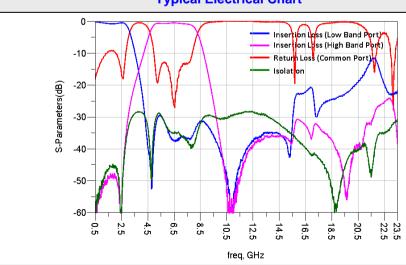
RFDIP2010L38A7B1U	Specification		
Frequency range	2400 ~ 2500 MHz	5150 ~ 7500MHz	
Insertion Loss (at 25°C)	0.50 dB max. (0.45 dB typ.)	1.00 dB max. (0.88 dB typ.)	
Insertion Loss (at -40 ~ +85°C)	0.65 dB max.	1.20 dB max.	
Insertion Loss (at -40 ~ +125°C)	0.80 dB max.	1.30 dB max.	
Attenuation	10 dB min. (11 dB typ.)@ 3600 MHz 25 dB min. (30 dB typ.)@ 4800 ~ 5000 MHz 25 dB min. (35 dB typ.)@ 7200 ~ 7500 MHz	20 dB min. (50 dB typ.)@ 824 ~ 915 MHz 20 dB min. (45 dB typ.)@ 1800 ~ 2300 MHz 45 dB min. (55 dB typ.)@ 2400 ~ 2500 MHz 10 dB min. (12 dB typ.)@ 3000 ~ 3900 MHz 25 dB min. (32 dB typ.)@ 10300 ~ 15000 MHz 20 dB min. (28 dB typ.)@ 15450 ~21000 MHz 15 dB min. (20 dB typ.)@ 21000 ~ 22500 MHz	
Isolation	45 dB min. (58 dB typ.)@ 2400 ~ 2500 MHz 25 dB min. (29 dB typ.)@ 5150 ~ 7500 MHz		
VSWR	2.0 max.		
Impedance	50Ω		
Power capacity	3W max		
Moisture sensitivity levels	LEVEL 1 (Refer to : IPC/JEDEC J-STD-020)		
HBM ESD	Pass 1KV on all pins (Base on AEC-Q200-002)		
MM ESD	Pass 200V (Base on EIA/JESD22-A115)		

Operating & Storage Condition (Component)
Operation Temperature Range: -40 ~ +125 °C
Storage Temperature Range: -40 ~ +125 °C

Storage Condition before Soldering (Included packaging material)

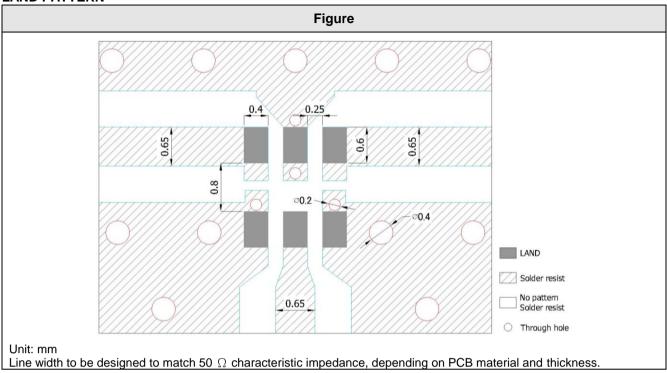
Storage Temperature Range: +5 ~ +40 °C Humidity: 30 to 70% relative humidity

Typical Electrical Chart





LAND PATTERN





RELIABILITY TEST

Test item	Test condition / Test method	Specification	
Solderability	*Solder bath temperature : 235 ± 5°C	At least 95% of a surface of each terminal electrode must be covered by fresh solder.	
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec		
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free		
Resistance to soldering heat JIS C 0050-5.4	*Preheating temperature : 120~150°C, 1 minute. *Solder temperature : 270±5°C *Immersion time : 10±1 sec Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 125°C. Loss of metallization on the edges of each electrode shall not exceed 25%.	
	room temperature for 24±2 hrs	electrode shall not exceed 25%.	
Drop Test JIS C 0044 Customer's specification.	*Height: 75 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units; 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 125°C.	
Vibration JIS C 0040	*Frequency: 10Hz~55Hz~10Hz(1min) *Total amplitude: 1.5mm	No mechanical damage. Electrical specification shall satisfy the	
	*Test times : 6hrs.(Two hrs each in three mutually perpendicular directions)	descriptions in electrical characteristics under the operational temperature range within -40 ~ 125°C.	
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N (LGA terminal series) ; 5N(≦0603) ; 10N(>0603) *Test time : 10±1 sec	No remarkable damage or removal of the termination.	
Bending test JIS C 0051- 7.4.1	The middle part of substrate shall be pressurized by means of the pressurizing rod at a rate of about 1 mm/s per second until the deflection becomes 1mm and then pressure shall be maintained for 5±1 sec. Measurement to be made after keeping at room temperature for 24±2 hours	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 125°C.	



Temperature cycle	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.
JIS C 0025	2. 10~15 minutes at room temperature,	Electrical specification shall satisfy the
	3. 30±3 minutes at +125°C±3°C,	descriptions in electrical characteristics under
	4. 10~15 minutes at room temperature,	the operational temperature range within -40 ~ 125°C.
	Total 100 continuous cycles	
	Measurement to be made after keeping at	
	room temperature for 24±2 hrs	
High temperature	*Temperature : 125°C±2°C	No mechanical damage.
JIS C 0021	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics under
	room temperature for 24±2 hrs	the operational temperature range within -40 ~
		125℃.
Humidity	*Humidity: 90% to 95% R.H.	No mechanical damage.
(steady conditions)	*Temperature : 40±2°C	Electrical specification shall satisfy the
JIS C 0022	*Time: 1000+24/-0 hrs.	descriptions in electrical characteristics under
	Measurement to be made after keeping at room	the operational temperature range within -40 ~
	temperature for 24±2 hrs	125℃.
	1000hrs data	
Low temperature	*Temperature : -40°C±2°C	No mechanical damage.
JIS C 0020	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics under
	room temperature for 24±2 hrs	the operational temperature range within -40 ~
		125℃.



SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2,

This product could sustain by reflow process three times, and the temperature below 260 °C.

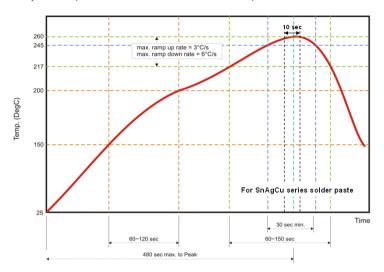


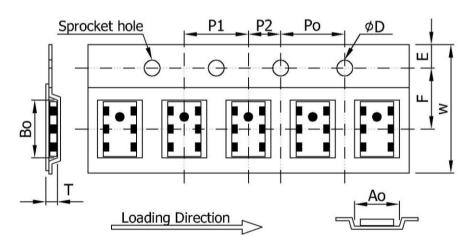
Fig 2. Infrared soldering profile

ORDERING CODE

RF	DIP	2010	L	38A7B1U
Walsin	Product Code	Dimension code	Application	Specification
RF device	DIP: Diplexer	Per 2 digits of Length, Width, Thickness :	L :	Design code
		e.g. :	2400 ~ 2500 MHz /	
		20 =	5150 ~ 7500MHz	
		Length 2.0 mm,		
		Width 1.2 mm,		
		10 =		
		Thickness 1.0 mm		

Minimum Ordering Quantity: 2000 pcs per reel.

PACKAGING

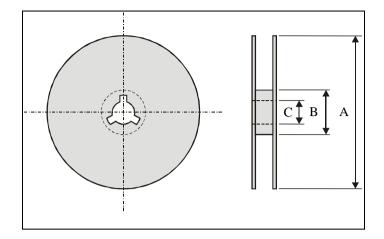


Black conductive Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	1.30 ± 0.10	2.25 ± 0.10	1.55 ± 0.05	1.10 ± 0.10	8.00 ± 0.10
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.05



Reel dimensions



Index	Α	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity:2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : +5 to +40 $^{\circ}$ C

Humidity: 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.